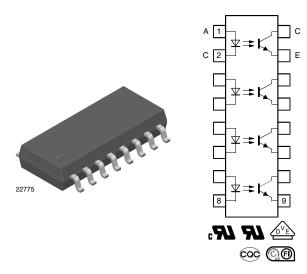


# Optocoupler, Phototransistor Output, Quad Channel, Half Pitch Mini-Flat Package



## **LINKS TO ADDITIONAL RESOURCES**







#### **DESCRIPTION**

The TCMT410. series consist of a phototransistor optically coupled to a gallium arsenide infrared-emitting diode in a 16 pin (quad channel) package.

## **FEATURES**

- Low profile package (half pitch)
- AC isolation test voltage 3750 V<sub>RMS</sub>
- Low coupling capacitance of typical 0.3 pF
- Current transfer ratio (CTR) selected into groups
- · Low temperature coefficient of CTR
- Wide ambient temperature range
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912





ROHS COMPLIANT HALOGEN

FREE GREEN (5-2008)

#### **APPLICATIONS**

- Programmable logic controllers
- Modems
- Answering machines
- · General applications

## **AGENCY APPROVALS**

Safety application model number covering all products in this datasheet is TCMT4100. This model number should be used when consulting safety agency documents.

- UL
- cUL
- DIN EN 60747-5-5 (VDE 0884)
- BSI
- FIMKO

| ORDERING INFORMATION       |                      |           |  |
|----------------------------|----------------------|-----------|--|
| T C M                      | T 4 1 0              | # SSOP-16 |  |
| F                          | PART NUMBER          |           |  |
| AGENCY CERTIFIED / PACKAGE |                      |           |  |
| AGENCY CENTIFIED / PACKAGE | 5 1                  | mA        |  |
| UL, cUL, FIMKO, BSI, VDE   | 50 to 600 100 to 300 |           |  |
| SSOP-16, quad channel      | TCMT4100             | TCMT4106  |  |
| SSOP-16, quad channel      | TCMT4100T0 (1)       | -         |  |

#### Notes

- · Available only on tape and reel.
- (1) Product is rotated 180° in tape and reel cavity.



| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |  |                   |             |                  |  |  |
|--|--|-------------------|-------------|------------------|--|--|
| PARAMETER  | TEST CONDITION                                 | SYMBOL            | VALUE       | UNIT             |  |  |
| INPUT  |  |                   |             |                  |  |  |
| Reverse voltage  |  | V <sub>R</sub>    | 6           | V                |  |  |
| Forward current  |  | I <sub>F</sub>    | 60          | mA               |  |  |
| Forward surge current  | t <sub>p</sub> ≤ 10 μs                         | I <sub>FSM</sub>  | 1.5         | Α                |  |  |
| Power dissipation  |  | P <sub>diss</sub> | 100         | mW               |  |  |
| Junction temperature   |  | Tj                | 125         | °C               |  |  |
| OUTPUT   |  |                   |             |                  |  |  |
| Collector emitter voltage  |  | V <sub>CEO</sub>  | 70          | V                |  |  |
| Emitter collector voltage  |  | V <sub>ECO</sub>  | 7           | V                |  |  |
| Collector current  |  | Ic                | 50          | mA               |  |  |
| Collector peak current   | $t_p/T = 0.5, t_p \le 10 \text{ ms}$           | I <sub>CM</sub>   | 100         | mA               |  |  |
| Power dissipation  |  | P <sub>diss</sub> | 150         | mW               |  |  |
| Junction temperature   |  | Tj                | 125         | °C               |  |  |
| COUPLER  |  |                   |             |                  |  |  |
| AC isolation test voltage (RMS)  | Related to standard climate 23/50<br>DIN 50014 | V <sub>ISO</sub>  | 3750        | V <sub>RMS</sub> |  |  |
| Total power dissipation per channel  |  | P <sub>tot</sub>  | 250         | mW               |  |  |
| Operating ambient temperature range  |  | T <sub>amb</sub>  | -40 to +100 | °C               |  |  |
| Storage temperature range  |  | T <sub>stg</sub>  | -40 to +125 | °C               |  |  |
| Soldering temperature (1)  |  | T <sub>sld</sub>  | 260         | °C               |  |  |

#### Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not
  implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute
  maximum ratings for extended periods of the time can adversely affect reliability.
- (1) Refer to reflow profile for soldering conditions for surface mounted devices. Also refer to "Assembly Instructions" (<u>www.vishay.com/doc?80054</u>).

| <b>ELECTRICAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |   |                    |      |      |      |      |  |  |  |
|--|---|--------------------|------|------|------|------|--|--|--|
| PARAMETER  | TEST CONDITION                                      | SYMBOL             | MIN. | TYP. | MAX. | UNIT |  |  |  |
| INPUT  | INPUT   |                    |      |      |      |      |  |  |  |
| Forward voltage  | $I_F = 50 \text{ mA}$                               | V <sub>F</sub>     | -    | 1.35 | 1.6  | V    |  |  |  |
| Junction capacitance   | $V_R = 0$ , $f = 1 MHz$                             | C <sub>j</sub>     | -    | 8    | -    | pF   |  |  |  |
| OUTPUT   |   |                    |      |      |      |      |  |  |  |
| Collector emitter voltage  | I <sub>C</sub> = 100 μA                             | V <sub>CEO</sub>   | 70   | -    | -    | V    |  |  |  |
| Emitter collector voltage  | I <sub>E</sub> = 100 μA                             | V <sub>ECO</sub>   | 7    | -    | -    | V    |  |  |  |
| Collector dark current   | $V_{CE} = 20 \text{ V}, I_F = 0 \text{ A}$          | I <sub>CEO</sub>   | =    | -    | 100  | nA   |  |  |  |
| COUPLER  |   |                    |      |      |      |      |  |  |  |
| Collector emitter saturation voltage   | $I_F = 10 \text{ mA}, I_C = 1 \text{ mA}$           | V <sub>CEsat</sub> | -    | -    | 0.3  | V    |  |  |  |
| Cut-off frequency  | $V_{CE}$ = 5 V, $I_F$ = 10 mA, $R_L$ = 100 $\Omega$ | f <sub>c</sub>     | -    | 100  | -    | kHz  |  |  |  |
| Coupling capacitance   | f = 1 MHz   | C <sub>k</sub>     | -    | 0.3  | -    | pF   |  |  |  |

#### Note

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering
evaluation. Typical values are for information only and are not part of the testing requirements.

| CURRENT TRANSFER RATIO (T <sub>amb</sub> = 25 °C, unless otherwise specified) |  |          |        |      |      |      |      |
|---|--|----------|--------|------|------|------|------|
| PARAMETER   | TEST CONDITION                             | PART     | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| $I_{C}/I_{F}$ $V_{CE} = 5 \text{ V}, I_{F} = 5 \text{ mA}$                    | V - 5 V I - 5 m A                          | TCMT4100 | CTR    | 50   | -    | 600  | %    |
|   | $V_{CE} = 5 \text{ V}, I_F = 5 \text{ mA}$ | TCMT4106 | CTR    | 100  | -    | 300  | %    |



| <b>SWITCHING CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |   |                  |      |      |      |      |  |
|---|---|------------------|------|------|------|------|--|
| PARAMETER   | TEST CONDITION  | SYMBOL           | MIN. | TYP. | MAX. | UNIT |  |
| Delay time  | $V_S = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega,$ (see Fig. 1)         | t <sub>d</sub>   | -    | 4    | -    | μs   |  |
| Rise time   | $V_S = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega,$ (see Fig. 1)         | t <sub>r</sub>   | -    | 5.5  | -    | μs   |  |
| Fall time   | $V_S = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega,$ (see Fig. 1)         | t <sub>f</sub>   | -    | 7.0  | -    | μs   |  |
| Storage time  | $V_S = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega,$ (see Fig. 1)         | ts               | -    | 1.5  | -    | μs   |  |
| Turn-on time  | $V_S = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega,$ (see Fig. 1)         | t <sub>on</sub>  | -    | 9.5  | -    | μs   |  |
| Turn-off time   | $V_S = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega,$ (see Fig. 1)         | t <sub>off</sub> | -    | 8.5  | -    | μs   |  |
| Turn-on time  | $V_S = 5 \text{ V}, I_F = 10 \text{ mA}, R_L = 1 \text{ k}\Omega,$ (see Fig. 2) | t <sub>on</sub>  | -    | 3    | -    | μs   |  |
| Turn-off time   | $V_S = 5 \text{ V}, I_F = 10 \text{ mA}, R_L = 1 \text{ k}\Omega,$ (see Fig. 2) | t <sub>off</sub> | -    | 20   | -    | μs   |  |

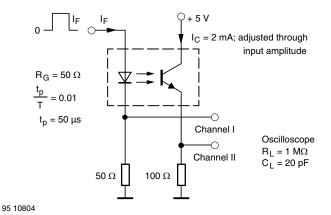


Fig. 1 - Test Circuit, Non-Saturated Operation

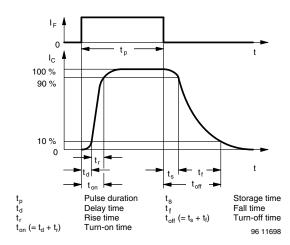


Fig. 3 - Switching Times

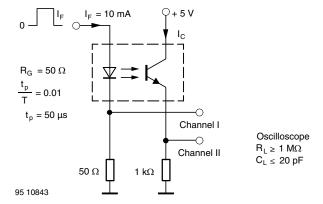


Fig. 2 - Test Circuit, Saturated Operation

| PARAMETER                                     | TEST CONDITION   | SYMBOL            | VALUE            | UNIT              |
|---|--|-------------------|------------------|-------------------|
| Climatic classification                       | According to IEC 68 part 1   |                   | 40 / 110 / 21    |                   |
| Comparative tracking index                    |  | CTI               | 175              |                   |
| Maximum rated withstanding isolation voltage  | t = 1 min  | V <sub>ISO</sub>  | 3750             | $V_{RMS}$         |
| Maximum transient isolation voltage           |  | V <sub>IOTM</sub> | 6000             | V                 |
| Maximum repetitive peak isolation voltage     |  | V <sub>IORM</sub> | 707              | V                 |
| Apparent charge test voltage (method A)       | $V_{\text{IORM}}$ x 1.6 = $V_{\text{PR}}$ , type and sample test,<br>t <sub>m</sub> = 60 s, partial discharge < 5 pC | V <sub>PR</sub>   | 1132             | V <sub>peak</sub> |
| Apparent charge test voltage (method B)       | $V_{IORM}$ x 1.875 = $V_{PR}$ , 100 % production test with $t_m$ = 1 s, partial discharge < 5 pC                     | $V_{PR}$          | 1326             | V <sub>peak</sub> |
| Isolation resistance                          | V <sub>IO</sub> = 500 V <sub>DC</sub> , T <sub>amb</sub> = 100 °C  | R <sub>IO</sub>   | 10 <sup>11</sup> | Ω                 |
| Isolation resistance (under fault conditions) | $V_{IO} = 500 V_{DC}, T_{amb} = T_{SI}$  | R <sub>IO</sub>   | 10 <sup>9</sup>  | Ω                 |
| Output safety power                           |  | Pso               | 265              | mW                |
| Input safety current                          |  | I <sub>SI</sub>   | 130              | mA                |
| Input safety temperature                      |  | T <sub>SI</sub>   | 150              | °C                |
| Creepage distance                             |  |                   | ≥ 5              | mm                |
| Clearance distance                            |  |                   | ≥ 5              | mm                |
| Insulation thickness, reinforced rated        | Per IEC 60950 2.10.5.1   | DTI               | ≥ 0.4            | mm                |

#### Note

## TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

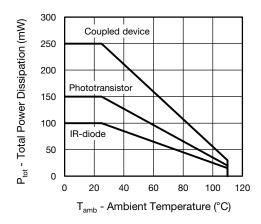


Fig. 4 - Total Power Dissipation vs. Ambient Temperature

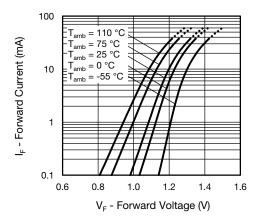


Fig. 5 - Forward Voltage vs. Forward Current

<sup>•</sup> As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.



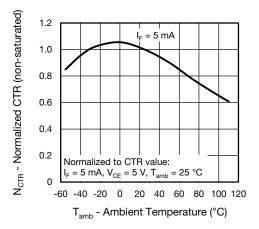


Fig. 6 - Normalized Current Transfer Ratio (non-saturated) vs.

Ambient Temperature

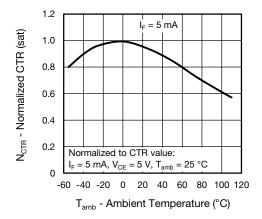


Fig. 7 - Normalized Current Transfer Ratio (saturated) vs.
Ambient Temperature

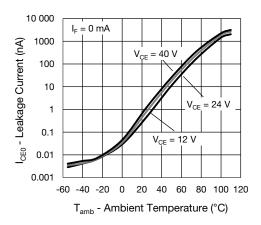


Fig. 8 - Collector Dark Current vs. Ambient Temperature

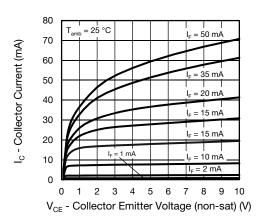


Fig. 9 - Collector Current vs. Collector Emitter Voltage (non-saturated)

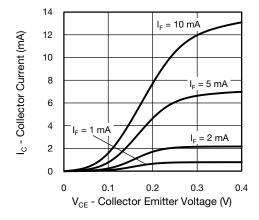


Fig. 10 - Collector Current vs. Collector Emitter Voltage (saturated)

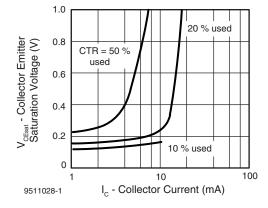


Fig. 11 - Collector Emitter Saturated Voltage vs. Collector Current





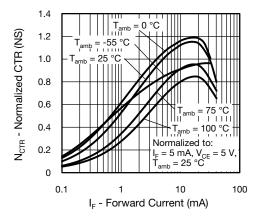


Fig. 12 - Normalized CTR (non-saturated) vs. Forward Current

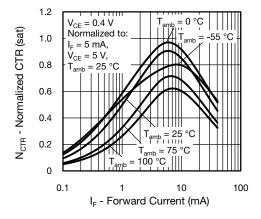


Fig. 13 - Normalized CTR (saturated) vs. Forward Current

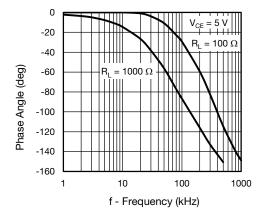


Fig. 14 - Phase Angle vs. Frequency

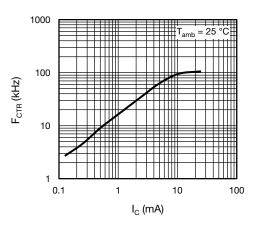


Fig. 15 - F<sub>CTR</sub> vs. Collector Current

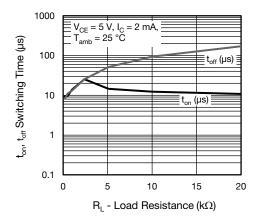


Fig. 16 - Switching Time vs. Load Resistance

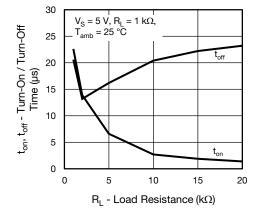


Fig. 17 - Turn-On / Turn-Off Time vs. Load Resistance



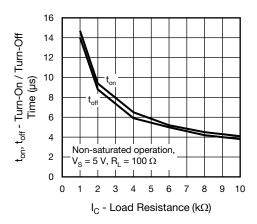
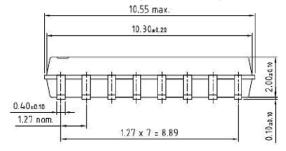
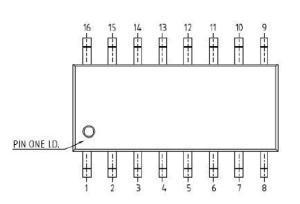
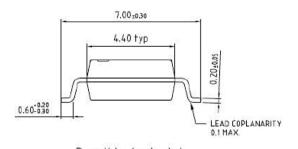


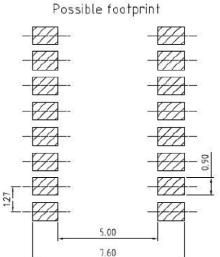
Fig. 18 - Switching Time vs. Load Resistance

# **PACKAGE DIMENSIONS** (in millimeters)

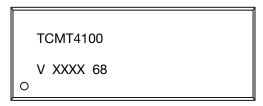








# PACKAGE MARKING (example)



#### Note

• XXXX = LMC (lot marking code)

## TAPE AND REEL PACKAGING FOR TCMT410X SERIES (in millimeters)

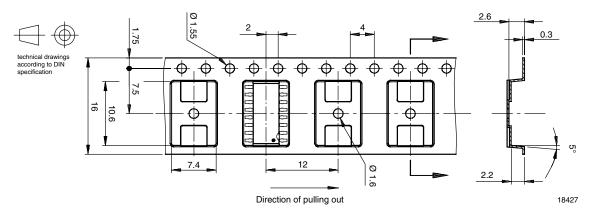


Fig. 19 - 2000 pcs/reel

# TAPE AND REEL PACKAGING FOR TCMT410XT0 SERIES (in millimeters)

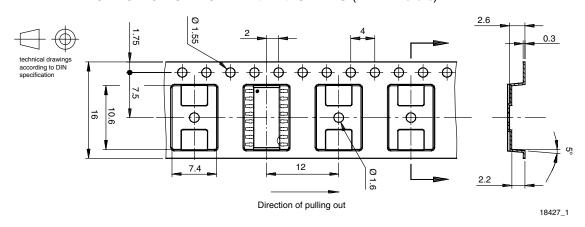


Fig. 20 - 2000 pcs/reel

#### **SOLDER PROFILE**

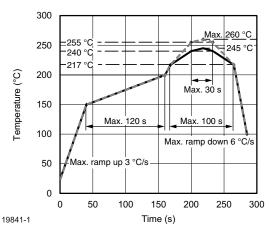


Fig. 21 - Lead (Pb)-free Reflow Solder Profile according to J-STD-020

## HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2

Floor life: unlimited

Conditions:  $T_{amb} < 30$  °C, RH < 85~%

Moisture sensitivity level 1, according to J-STD-020



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